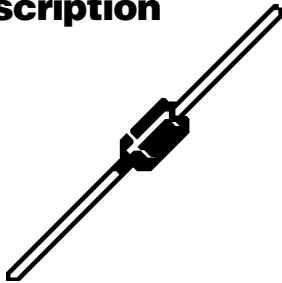
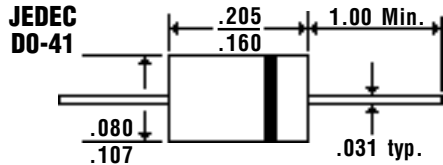


Description



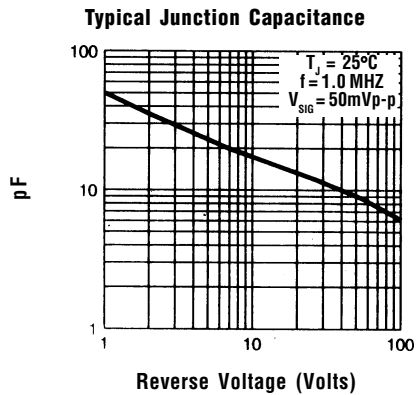
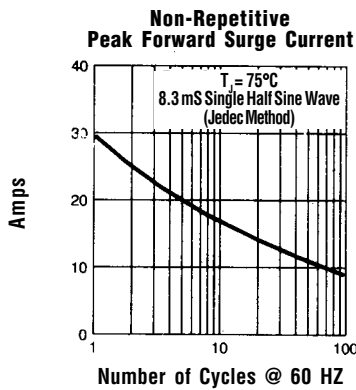
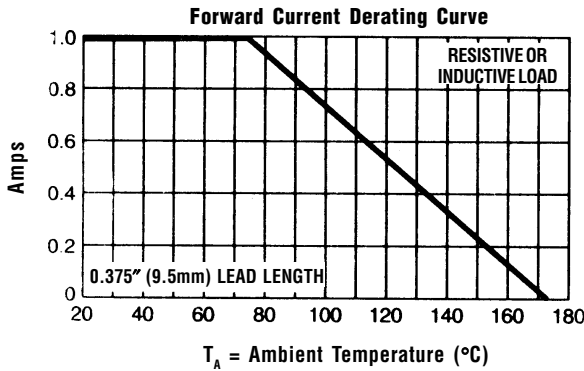
Mechanical Dimensions



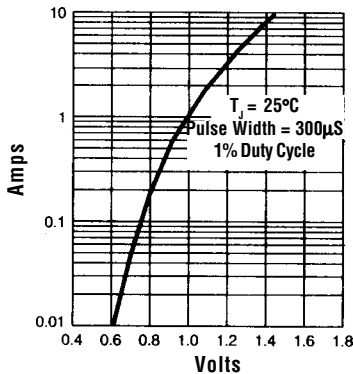
Features

- HIGH TEMPERATURE METALLURGICALLY BONDED CONSTRUCTION
- SINTERED GLASS CAVITY-FREE JUNCTION
- 1.0 AMP OPERATION @ $T_A = 55^\circ\text{C}$, WITH NO THERMAL RUNAWAY
- TYPICAL $I_R < 0.1 \mu\text{Amp}$

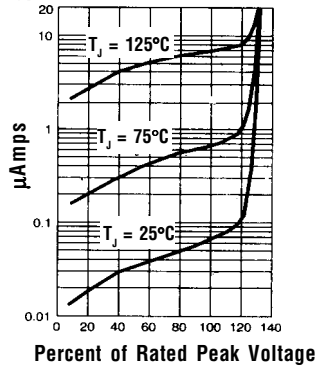
Electrical Characteristics @ 25°C.	GP10A . . . 10M Series							Units	
Maximum Ratings	GP10A	GP10B	GP10D	GP10G	GP10J	GP10K	GP10M		
Peak Repetitive Reverse Voltage... V_{RRM}	50	100	200	400	600	800	1000	Volts	
RMS Reverse Voltage... $V_{R(rms)}$	35	70	140	280	420	560	700	Volts	
DC Blocking Voltage... V_{DC}	50	100	200	400	600	800	1000	Volts	
Average Forward Rectified Current... $I_{F(av)}$ Current 3/8" Lead Length @ $T_A = 75^\circ\text{C}$			1.0			Amps	
Non-Repetitive Peak Forward Surge Current... I_{FSM} ½ Sine Wave Superimposed on Rated Load			30			Amps	
Forward Voltage @ 1.0A... V_F	<		1.1	> <		1.2	>		Volts
Full Load Reverse Current... $I_R(av)$ Full Cycle Average @ $T_A = 75^\circ\text{C}$			30			μAmps	
DC Reverse Current... I_R @ Rated DC Blocking Voltage	$T_A = 75^\circ\text{C}$			5.0		μAmps	
	$T_A = 125^\circ\text{C}$			50		μAmps	
Typical Junction Capacitance... C_j (Note 1)	<		8.0	> <		7.0	>		pF
Typical Thermal Resistance... $R_{\theta JA}$ (Note 2)			55			$^\circ\text{C/W}$	
Typical Reverse Recovery Time... t_{RR} (Note 3)			2.0			μS	
Operating & Storage Temperature Range... T_J, T_{STRG} -65 to 175							$^\circ\text{C}$	



Typical Instantaneous Forward Characteristics



Typical Reverse Characteristics



Ratings at 25 Deg. C ambient temperature unless otherwise specified.

Single Phase Half Wave, 60 HZ Resistive or Inductive Load.

For Capacitive Load, Derate Current by 20%.

- NOTES:**
1. Measured @ 1 MHz and applied reverse voltage of 4.0V.
 2. Thermal Resistance from Junction to Ambient at 3/8" Lead Length, P.C. Board Mounted.
 3. Reverse Recovery Condition $I_F = 0.5A$, $I_R = 1.0A$, $I_{RR} = 0.25A$.